

Express Mail Label No. EV 411109115 US

PATENT APPLICATION  
Docket No. 11675.163.2



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Terry N. Williams )  
Serial No.: 09/761,375 )  
Filed: January 16, 2001 )  
For: BUFFERED RESIST PROFILE ETCH OF A )  
FIELD EMISSION DEVICE STRUCTURE )  
Examiner: Jurie Yun )  
Confirmation No.: 5328 )

AMENDMENT AND RESPONSE

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed from the United States Patent and Trademark Office on July 25, 2003, please enter the following amendments and remarks into the file of the above-identified application.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims begin on page 4 of this paper.

Amendments to the Drawings begin on page 11 of this paper and include both a replacement sheet and an annotated sheet showing changes.

Remarks begin on page 12 of this paper.

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